Programmable Hi-performance IR Pre-heating Plate Model IRPH-4



designed for bottom pre-heating of multilayer & high heat sink Printed Circuit Boards

The IRPH-4 Pre-heating Plate enhances the effectiveness of the MFRS500SUSB systems. It provides bottom heating to the PCB under repair, therefore minimizing the risk of thermal damage to expensive SMD ICs and warping of expensive multilayer PCBs. Additionally it also speeds up the rework/repair process.



Features:

- High quality, long life IR Ceramic Heating Elements ensure fast and even pre-heating with high efficiency
- in-built temperature measurement with thermocouple allows continuous monitoring of PCB temperature
- Pre-set temperature is achieved accurately and remains stable due to closed loop PID control design.

Specifications:

- Heating Power : 600 Watt
- Plate Area
- : 130 x 130mm
- Heating Source : If
- : IR Ceramic Heater

Why bottom Preheating is recommended ?

Today's electronics design has higher density of expensive devices on the multilayer PCBs which inherently require gentle pre-heating of PCBs to avoid thermal damaging of expensive SMD ICs, and also must avoid warping of PCBs.

If pre-heating is not used, it can lead to pad lifting, delamination, warping and burning of expensive PCBs & large SMD ICs during rework/repair. Beside these visible defects, the invisible defects like internal layer cracking etc. will also result if pre-heating is not used.

To avoid above failures, PCBs will normally need even pre-heating around 120°C on top side while reworking. The Pre-heater model IRPH-4 serves this purpose. PCBs are heated evenly and gently from bottom side for safe reworking of SMD ICs.

- Temperature Sensor
- Temperature Range
- Measurement Range
- : K-type Thermocouple
- : 50°C ~ 350°C
- : 0~600°C



PCB warping/burning possibility without pre-heating



Safe reworking of SMD ICs using bottom Preheater

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